

Features

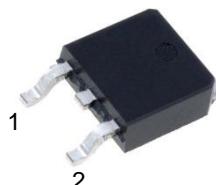
- Low reverse current
- Good surge current capability
- Low capacitive charge
- No reverse recovery current
- Halogen free, RoHs compliant

V_{RRM}	=	1200	V
$I_F (T_c=157^\circ C)$	=	10	A
Q_C	=	48	nC

Benefits

- System efficiency improvement over Si diodes
- Higher switching frequency
- Increased power density
- Essentially no switching losses

Package



TO-252-2

Applications

- Switch mode power supplies (SMPS)
- Uninterruptible power supplies
- On Board Charger
- UPS



Part Number	Package	Marking
ASZD010120D	TO-252-2	ASZD010120D

Maximum Ratings (T_c=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Value	Unit
V _{RRM}	Repetitive peak reverse voltage		1200	V
V _{RSM}	Non-repetitive peak reverse voltage		1200	V
I _F	Continuous forward current	T _c =25°C	30	A
		T _c =135°C	15	
		T _c =157°C	10	
I _{FRM}	Repetitive forward surge current	T _c =25°C , t _p =10ms, Half Sine Pulse T _c =110°C , t _p =10ms, Half Sine Pulse	57 41.5	A
I _{FSM}	Non-Repetitive forward surge current	T _c =25°C , t _p =10ms, Half Sine Pulse T _c =110°C , t _p =10ms, Half Sine Pulse	90 69.5	A
j ² dt	i ² t value	T _c =25°C , t _p =10ms, Half Sine Pulse T _c =110°C , t _p =10ms, Half Sine Pulse	40.5 24	A ² S
P _{tot}	Power dissipation	T _c =25°C T _c =110°C	115 50	W
T _j	Operating junction temperature		-55~175	°C
T _{stg}	Storage temperature		-55~150	°C

Electrical Characteristics (T_j=25°C unless otherwise specified)
Static Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
V _{DC}	DC blocking voltage	T _j =25°C	1200			V
V _F	Diode forward voltage	I _F =10A T _j =25°C I _F =10A T _j =175°C		1.4 2.0	1.7	V
I _R	Reverse current	V _R =1200V T _j =25°C V _R =1200V T _j =175°C			100 200	μA

AC Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
Q _C	Total capacitive charge	V _R =800V T _j =25°C $Q_C = \int_0^{V_R} C(V)dV$		48		nC
C	Total capacitance	V _R =0V f=1MHz V _R =400V f=1MHz V _R =800V f=1MHz		695 46 35		pF

Thermal Characteristics

Symbol	Parameter		Value			Unit
			Min.	Typ.	Max.	
R _{th(jc)}	Thermal resistance from junction to case			1.3		°C/W

Typical Performance

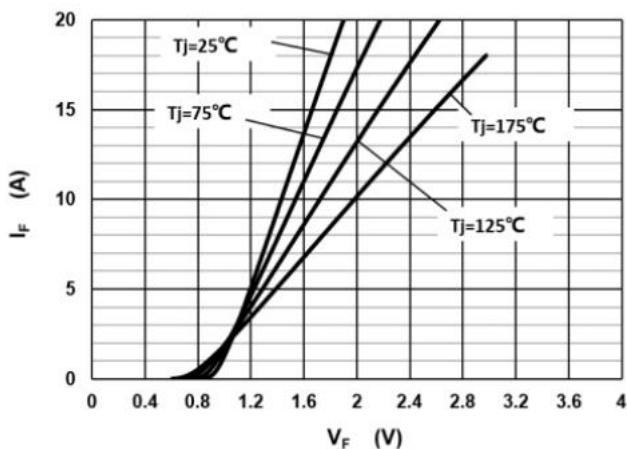


Figure 1. Typical forward characteristics

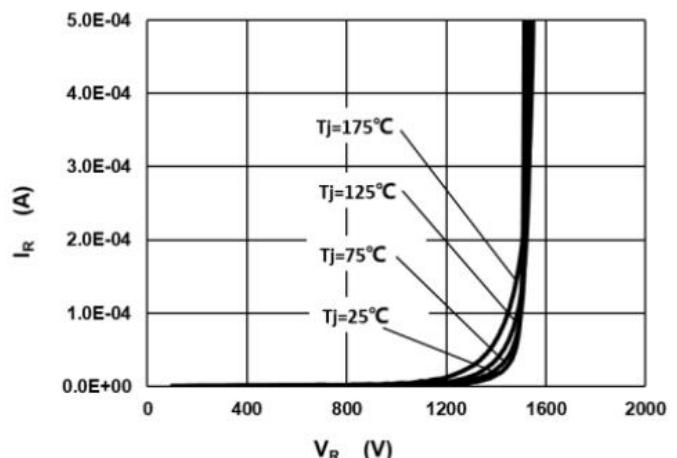


Figure 2. Typical reverse current as function of reverse voltage

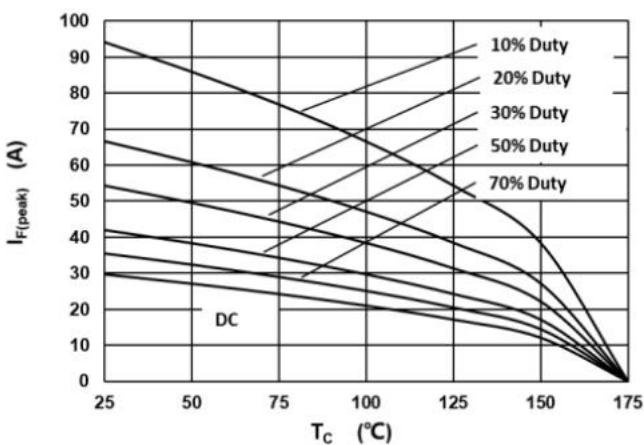


Figure 3. Diode forward current as function of temperature, D=duty cycle

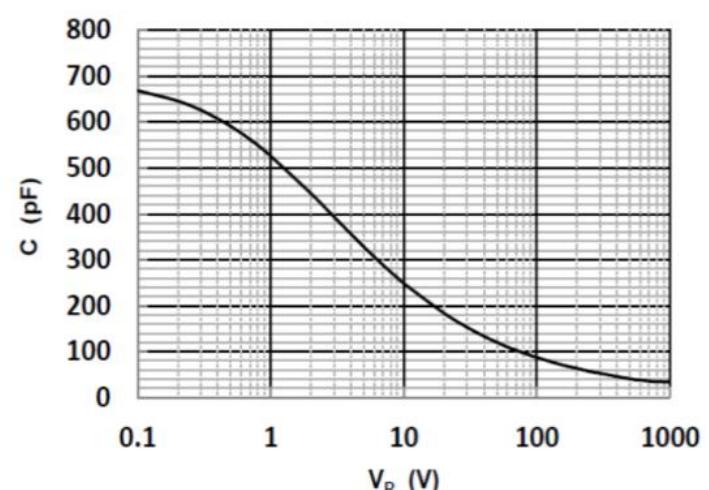


Figure 4. Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_j=25^\circ\text{C}$

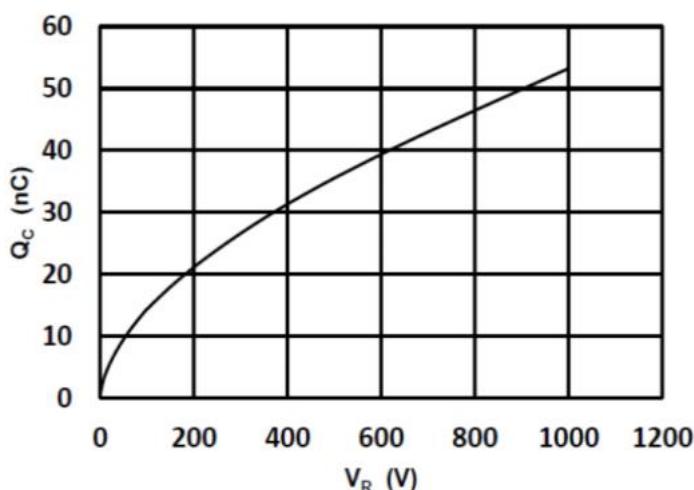


Figure 5. Typical reverse charge as function of reverse voltage

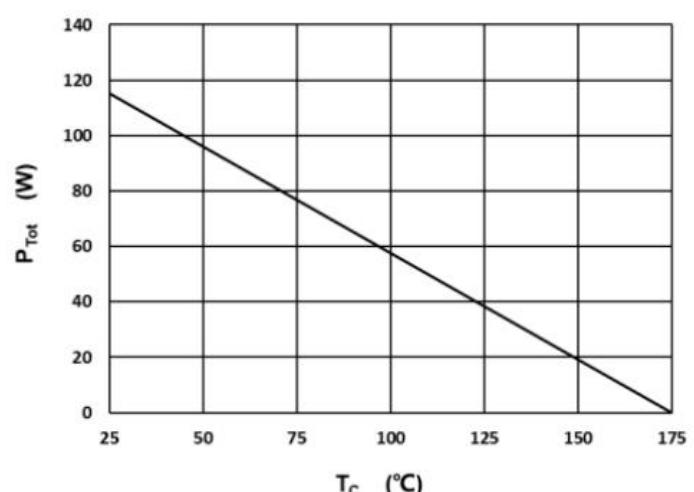


Figure 6. Power dissipation as function of case temperature

Typical Performance

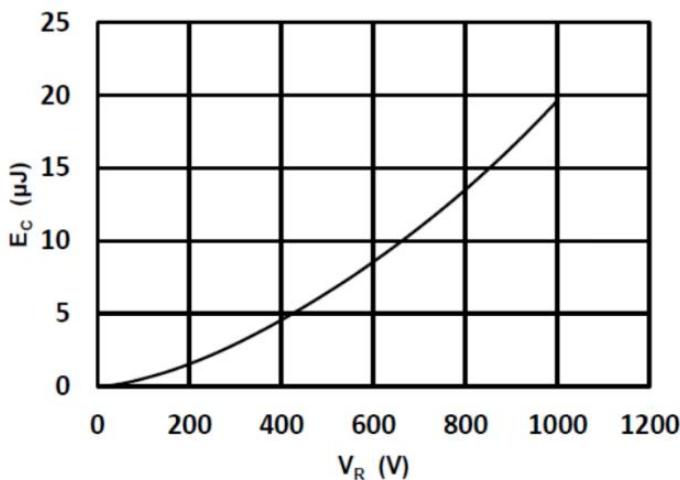


Figure 7. Capacitance stored energy

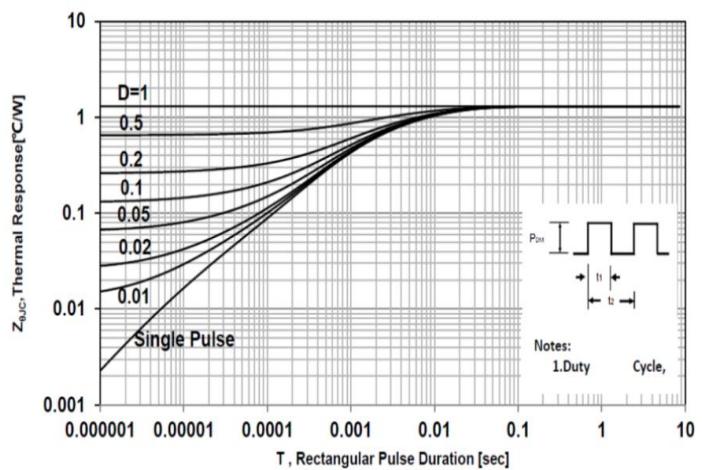
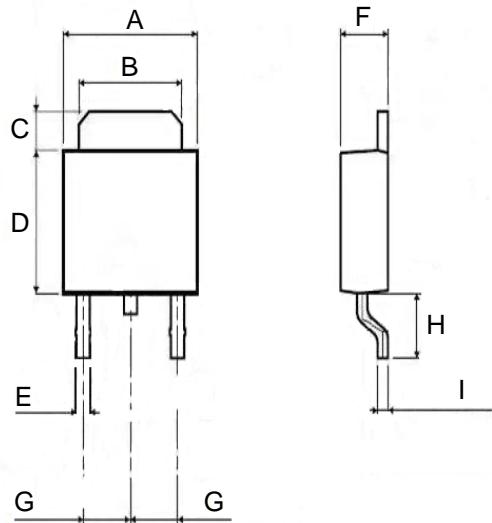


Figure 8. Max. transient thermal impedance

Package Dimensions

Package TO-252-2



Symbol	Min. (mm)	Typ. (mm)	Max. (mm)
A	6.30	6.60	6.73
B	5.21	5.34	5.46
C	0.89	1.08	1.27
D	6.00	6.12	6.23
E	0.64	0.76	0.88
F	2.20	2.30	2.40
G	-	2.286 BSC	-
H	-	2.743 REF	-
I	-	0.508 BSC	-